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|-----------------------------------|--------------------------|---|-------------|
| <b>Notice of References Cited</b> | Application/Control No.  | Applicant(s)/Patent Under Reexamination ABYS ET AL. |             |
|                                   | Examiner<br>Monica Lewis | Art Unit<br>2822                                    | Page 1 of 1 |

**U.S. PATENT DOCUMENTS**

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**NON-PATENT DOCUMENTS**

|   |   |   |
|---|---|---|
| * |   | Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)   |
| * | U | Suppression of Tin Whisker Growth through Optimized Tin Plating Chemistry Formulation Technistan, 2004.<br><a href="http://www.technic.com">www.technic.com</a> |
|   | V |   |
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